

P-Channel Power MOSFET

-30V, -30A, 15mΩ

Features

- Fast Switching
- Suitable for 4.5V drive applications
- Pb-free plating
- RoHS compliant
- Halogen-free mold compound

- Load Switch
- Networking

KEY PERFORMANCE PARAMETERS				
PARAMETER		VALUE	UNIT	
V_{DS}		-30	V	
R _{DS(on)} (max)	V _{GS} = -10V	15	mΩ	
	V _{GS} = -4.5V	30		
Q_{g}		4.1	nC	

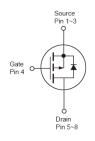






PDFN33





Notes: Moisture sensitivity level: level 3. Per J-STD-020

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V_{DS}	-30	V	
Gate-Source Voltage		V_{GS}	±20	V	
(Note 1)	T _C = 25°C	l _D	-30	А	
Continuous Drain Current (Note 1)	T _C = 100°C		-19		
Pulsed Drain Current (Note 2)		I _{DM}	-120	Α	
Total Power Dissipation @ T _C = 25°C		Р _{ртот}	23	W	
Operating Junction and Storage Temperature Range		T _J , T _{STG}	- 55 to +150	°C	

THERMAL PERFORMANCE				
PARAMETER	SYMBOL	LIMIT	IMIT UNIT	
Junction to Case Thermal Resistance	R _{eJC}	5.4	°C/W	
Junction to Ambient Thermal Resistance	R _{OJA}	62	°C/W	

Notes: $R_{\Theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistances. The case thermal reference is defined at the solder mounting surface of the drain pins. $R_{\Theta JA}$ is guaranteed by design while $R_{\Theta CA}$ is determined by the user's board design. $R_{\Theta JA}$ shown below for single device operation on FR-4 PCB in still air.



PARAMETER	CONDITIONS	SYMBOL	MIN	TYP	MAX	UNIT
Static (Note 3)					•	
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = -250\mu A$	BV _{DSS}	-30			V
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	V _{GS(TH)}	-1.2	-1.6	-2.5	V
Gate Body Leakage	$V_{GS} = \pm 20V, V_{DS} = 0V$	I _{GSS}			±100	nA
Zero Gate Voltage Drain Current	$V_{DS} = -30V, V_{GS} = 0V$	I _{DSS}			-1	μA
Drain-Source On-State Resistance	$V_{GS} = -10V, I_D = -8A$	R _{DS(ON)}		13	15	mΩ
	$V_{GS} = -4.5V, I_D = -6A$			22	30	
Dynamic (Note 4)						
Total Gate Charge	$V_{DS} = -15V, I_{D} = -8A,$ $V_{GS} = -4.5V$	Qg		14.6		
Gate-Source Charge		Q_{gs}		4.1		nC
Gate-Drain Charge		Q_{gd}		6.3		
Input Capacitance	$V_{DS} = -15V, V_{GS} = 0V,$ f = 1.0MHz	C _{iss}		1730		
Output Capacitance		C _{oss}		180		pF
Reverse Transfer Capacitance		C _{rss}		125		
Switching (Note 5)						
Turn-On Delay Time		t _{d(on)}		9		
Turn-On Rise Time	$V_{DD} = -15V,$ $R_{GEN} = 6\Omega,$ $I_{D} = -1A, V_{GS} = -10V,$	t _r		21.8		
Turn-Off Delay Time		t _{d(off)}		59.8		ns
Turn-Off Fall Time		t _f		14.4		
Source-Drain Diode (Note 3)	•	•				
						1

Notes:

- 1. Current limited by package
- 2. Pulse width limited by the maximum junction temperature
- 3. Pulse test: PW \leq 300 μ s, duty cycle \leq 2%
- 4. For DESIGN AID ONLY, not subject to production testing.
- 5. Switching time is essentially independent of operating temperature.



Taiwan Semiconductor

ORDERING INFORMATION

PART NO.	PACKAGE	PACKING
TSM150P03PQ33 RGG	PDFN33	5,000pcs / 13"Reel

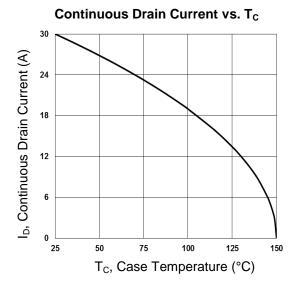
Note:

- 1. Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- 2. Halogen-free according to IEC 61249-2-21 definition

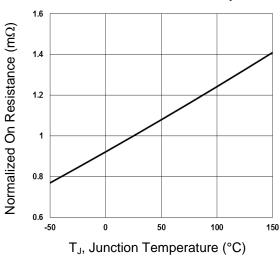


CHARACTERISTICS CURVES

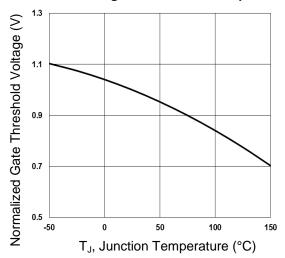
(T_C = 25°C unless otherwise noted)



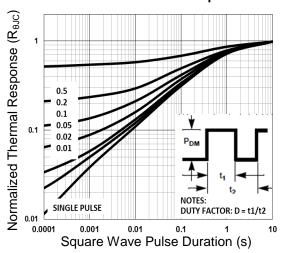
On-Resistance vs. Junction Temperature



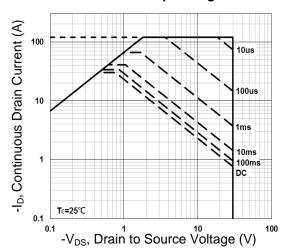
Threshold Voltage vs. Junction Temperature



Normalized Thermal Transient Impedance Curve



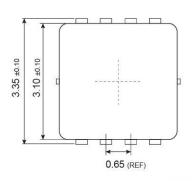
Maximum Safe Operating Area

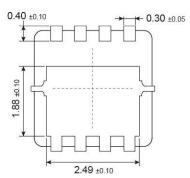


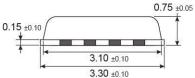


PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

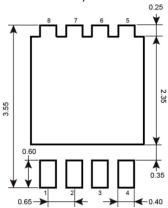
PDFN33







SUGGESTED PAD LAYOUT (Unit: Millimeters)



MARKING DIAGRAM



Y = Year Code

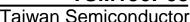
M = Month Code for Halogen Free Product

 \mathbf{O} =Jan \mathbf{P} =Feb \mathbf{Q} =Mar \mathbf{R} =Apr

S = May T = Jun U = Jul V = Aug

W =Sep X =Oct Y =Nov Z =Dec

 \mathbf{L} = Lot Code (1~9, A~Z)





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